



CERTIFICATE



This is to certify that

Ardentec Corporation

TSP1, TSP2 and TSOB, No. 3, Gongye 3rd Rd., KS, No. 24, Wenhua Rd., GS, No. 9, Renyi Rd., and PS, 1F, 6~7F, No. 12, Guangfu North Rd., Hukou Township, Hsinchu County, 303 Taiwan, R.O.C.

has implemented and maintains an **Information Security Management System**.

Scope:

The Information Security Management System associated with semiconductor test services "Circuit Probe(CP), Final Test(FT) and Wafer Level Chip Scale Packaging(WLCSP)" Process provided from (a) TSP1, TSP2 and TSOB, No.3, Gongye 3rd Rd.,(b) KS, No.24, Wenhua Rd.,(c) GS, No.9, Renyi Rd.,(d) PS, 1F and 6~7F., No.12, Guangfu North Rd., Hukou Township, Hsinchu County 303, Taiwan, R.O.C.

With reference to Statement of Applicability (SOA): at Doc: AG0054-1, Version 6

Through an audit, documented in a report, it was verified that the management system fulfills the requirements of the following standard:

ISO / IEC 27001: 2022

Certificate registration no. 20000173 ISMS22

Date of revision 2025-01-27

Date of certification 2023-02-06

Valid until 2026-02-05





DQS Inc.

DQS IS A MEMBER OF



David Tellez Managing Director

Accredited Body: DQS Inc., 1500 McConnor Parkway, Suite 400, Schaumburg, IL 60173 USA Administrative Office: DQS Taiwan Inc., 8F, 23, Yuan Huan West Road, Feng Yuan Dist., Taichung City, Taiwan 420

The validity of the certification can only be verified by the QR-code.